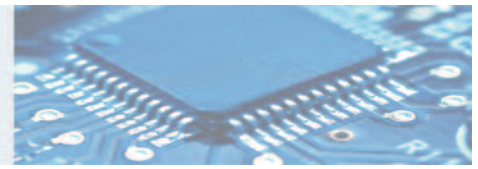




# INTERFLUX® DP 5505IC

Lead-free solder paste



Interflux® DP 5505IC is a high stability no-clean lead-free solder paste with low voiding properties.



High stability on the stencil



Low voiding



Perfect for vapour phase soldering as well as normal reflow



Absolutely halogen free



Smooth residue , improved cleaning ability



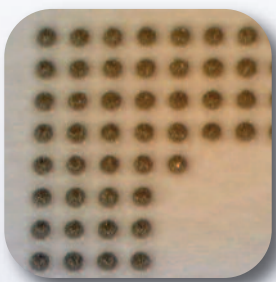
No health hazard labelling



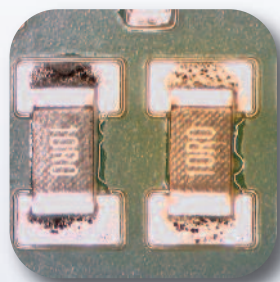
The DP 5505IC is an optimised version of the DP 5505. The chemistry has been developed to improve voiding behaviour, vapour phase compatibility and cleaning ability of the residues after reflow.

The paste maintains its high stability properties on the stencil in combination with absolutely no halogens.

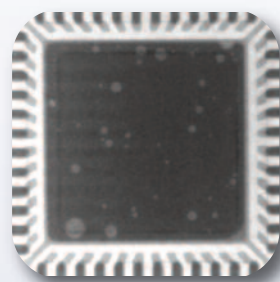
In addition the DP 5505IC has no more health hazard labelling (GHS) and is very economical in price.



Sharp printing image µBGA



Vapour phase soldering



Voiding on QFN capability



No health hazard pictogram



Lead-free alloys



Type 3 and Type 4 (Type 5 for certain alloys)



Jars, cartridges and syringes

